

Fig. 1

Cross section of a III-V nitride-based blue-violet semiconductor laser with 4H-polytype on 4H-AlN/4H-SiC. Cleaved facet to form the reflective mirror is on (0001) c-face. substrate can be inclined to <1-100> direction.

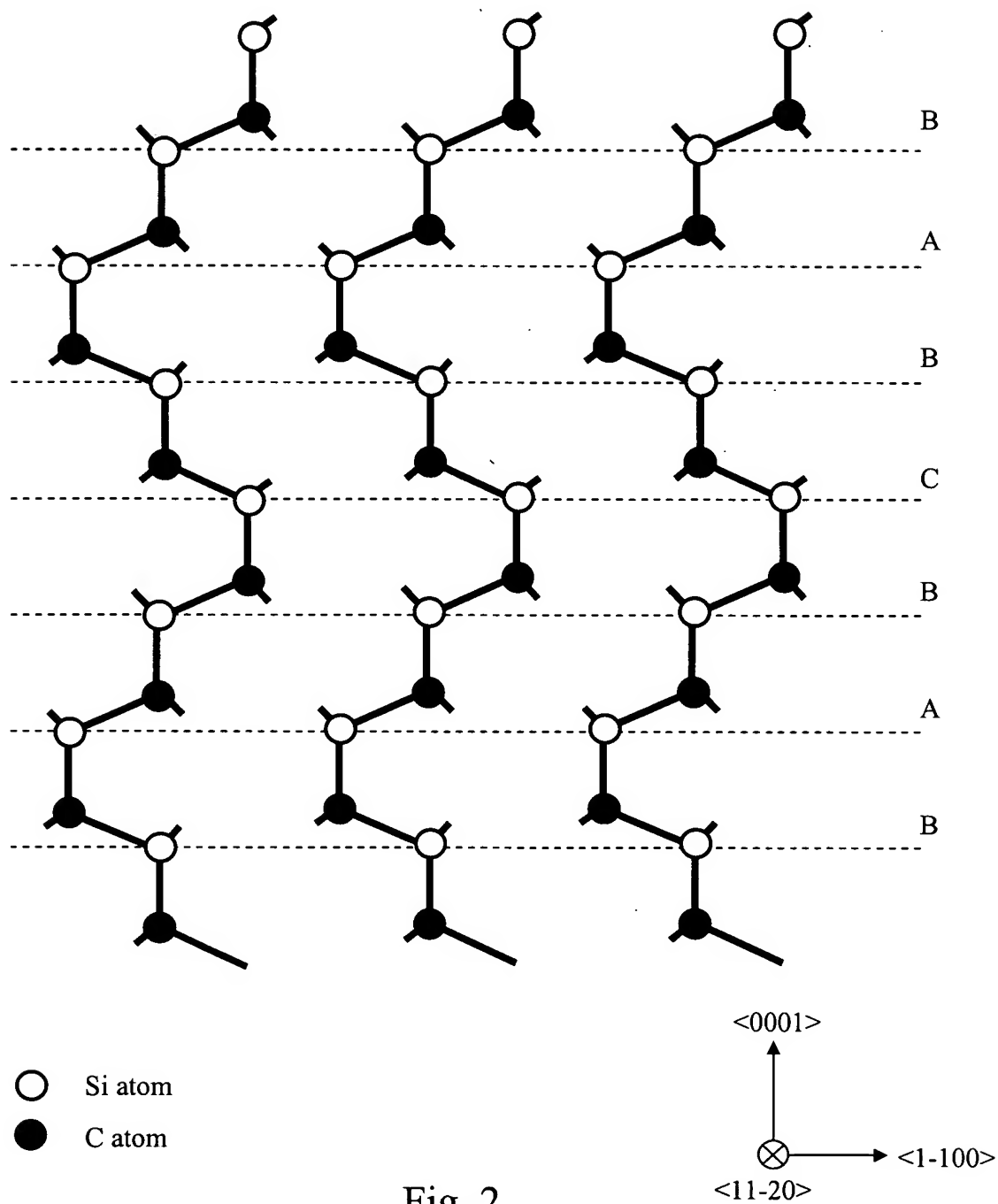


Fig. 2

Schematic drawing of atomic configuration on 4H-SiC (11-20) a-face.

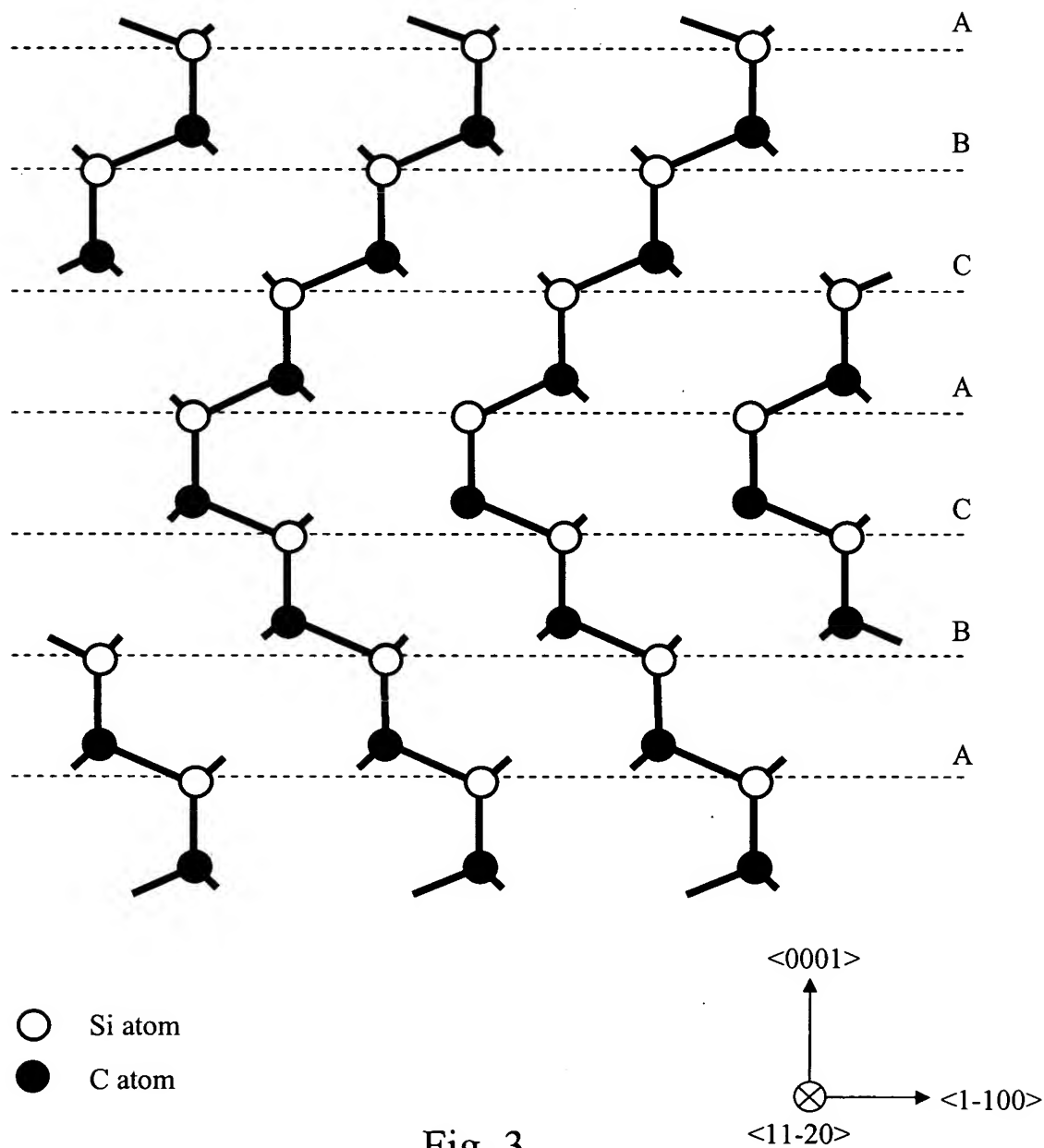


Fig. 3

Schematic drawing of atomic configuration on 6H-SiC (11-20) a-face.

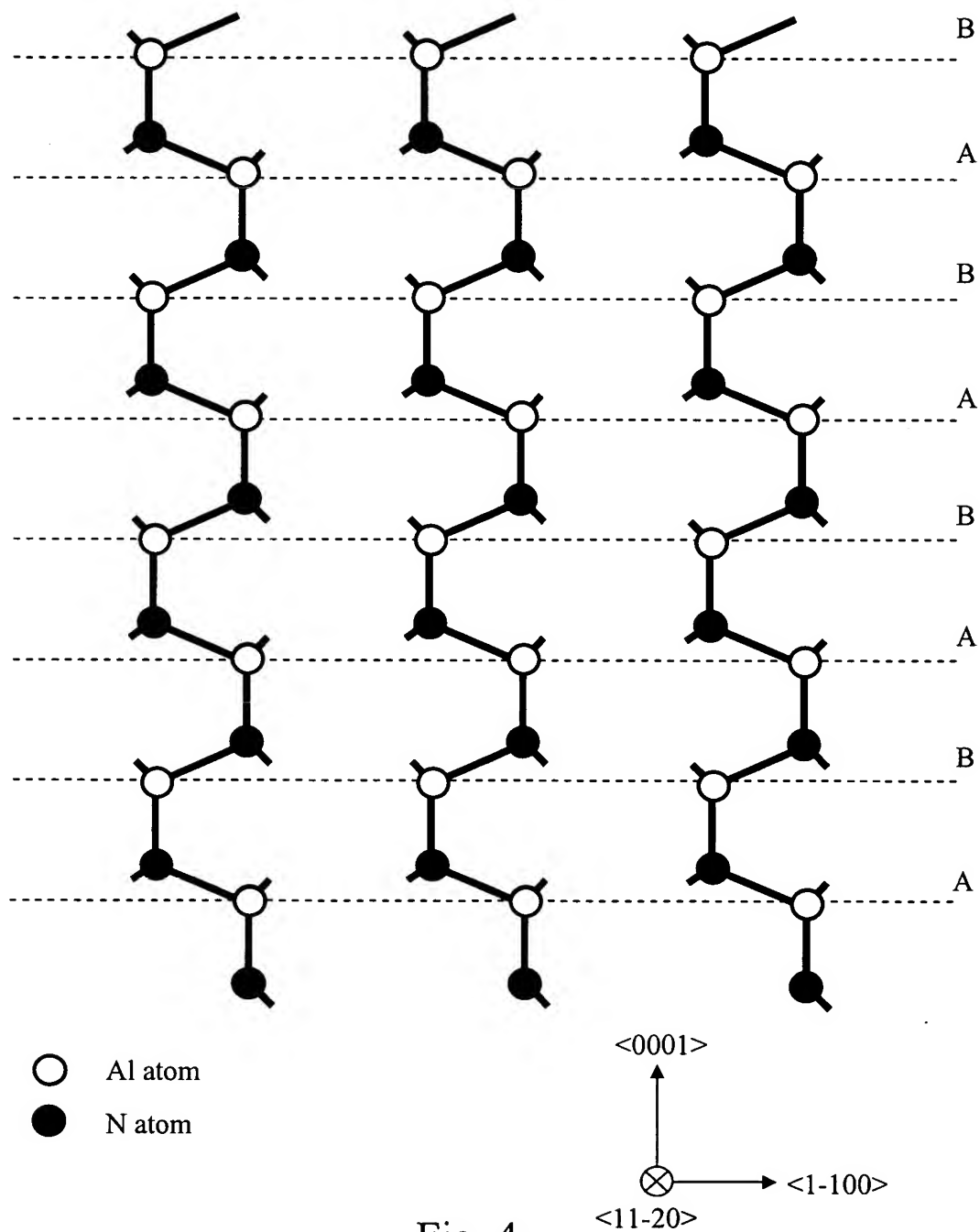


Fig. 4

Schematic drawing of atomic configuration on 2H-AlN (11-20) a-face.
All of the III-V nitride with 2H-polytype shows same configuration.

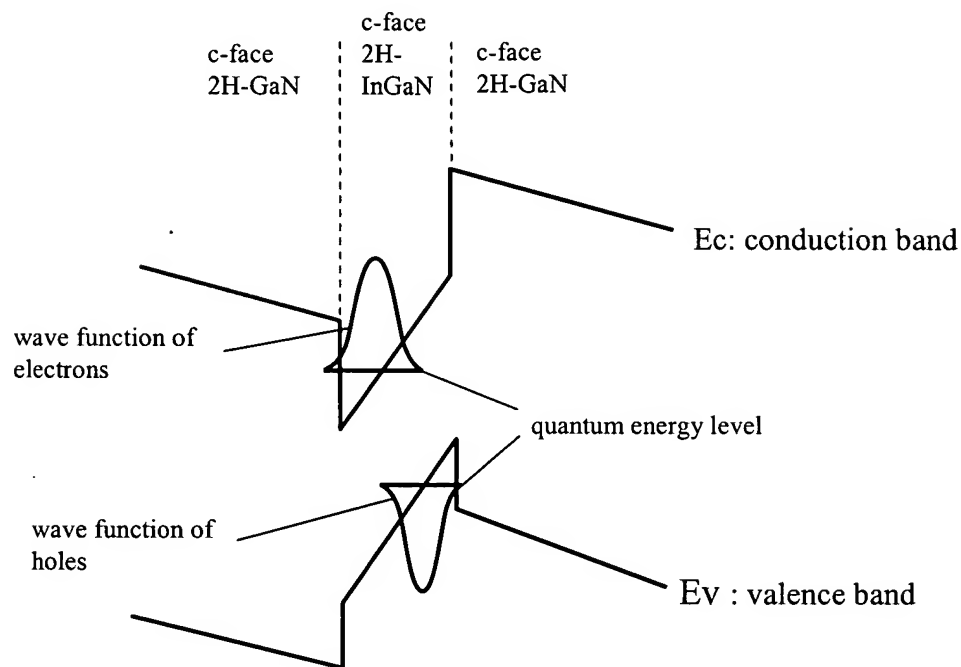


Fig. 5

Schematic band diagram of InGaN/GaN quantum well with 2H-polytype on a c-face substrate

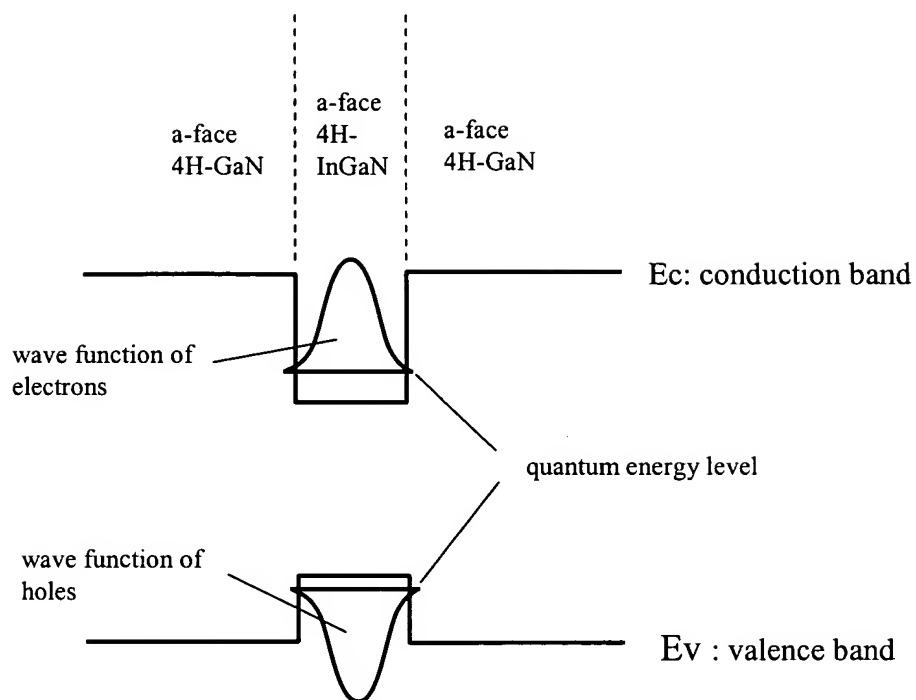
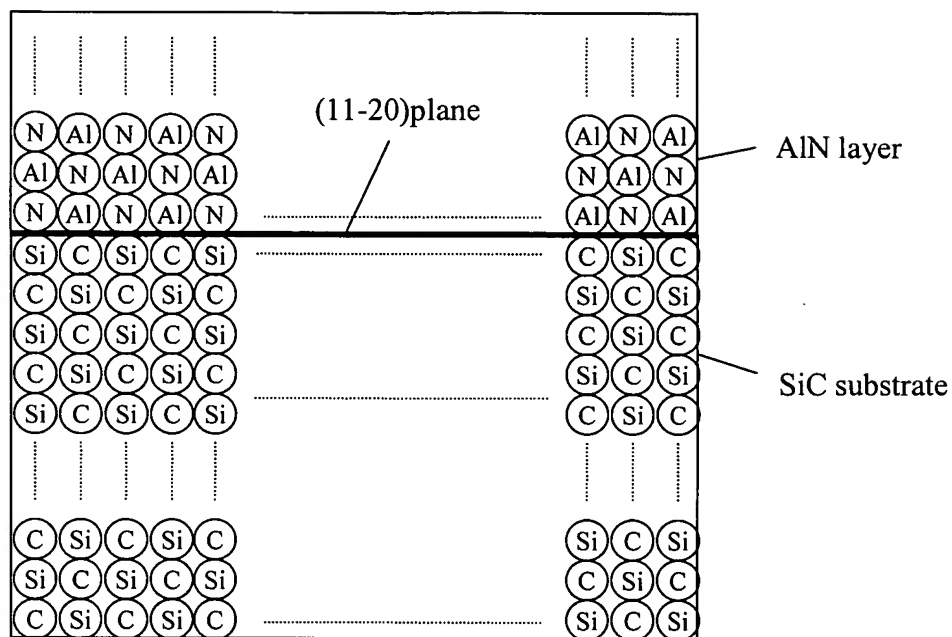


Fig. 6

Schematic band diagram of InGaN/GaN quantum well with 4H-polytype on an a-face substrate

(a) on a non-polar face



(b) on a polar face

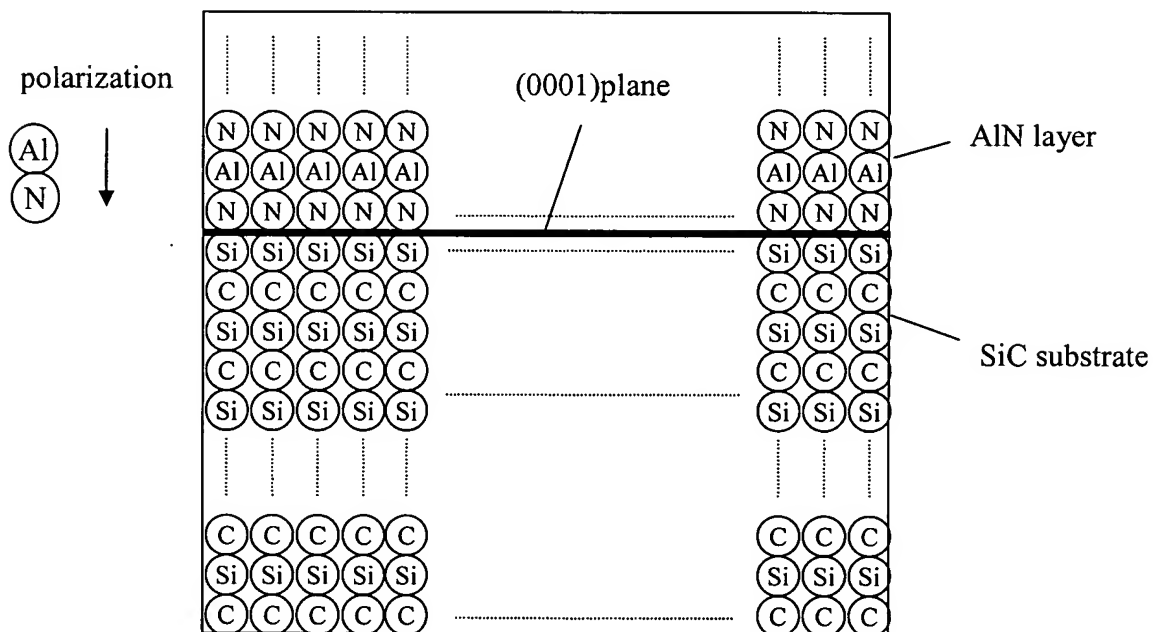


Fig. 7

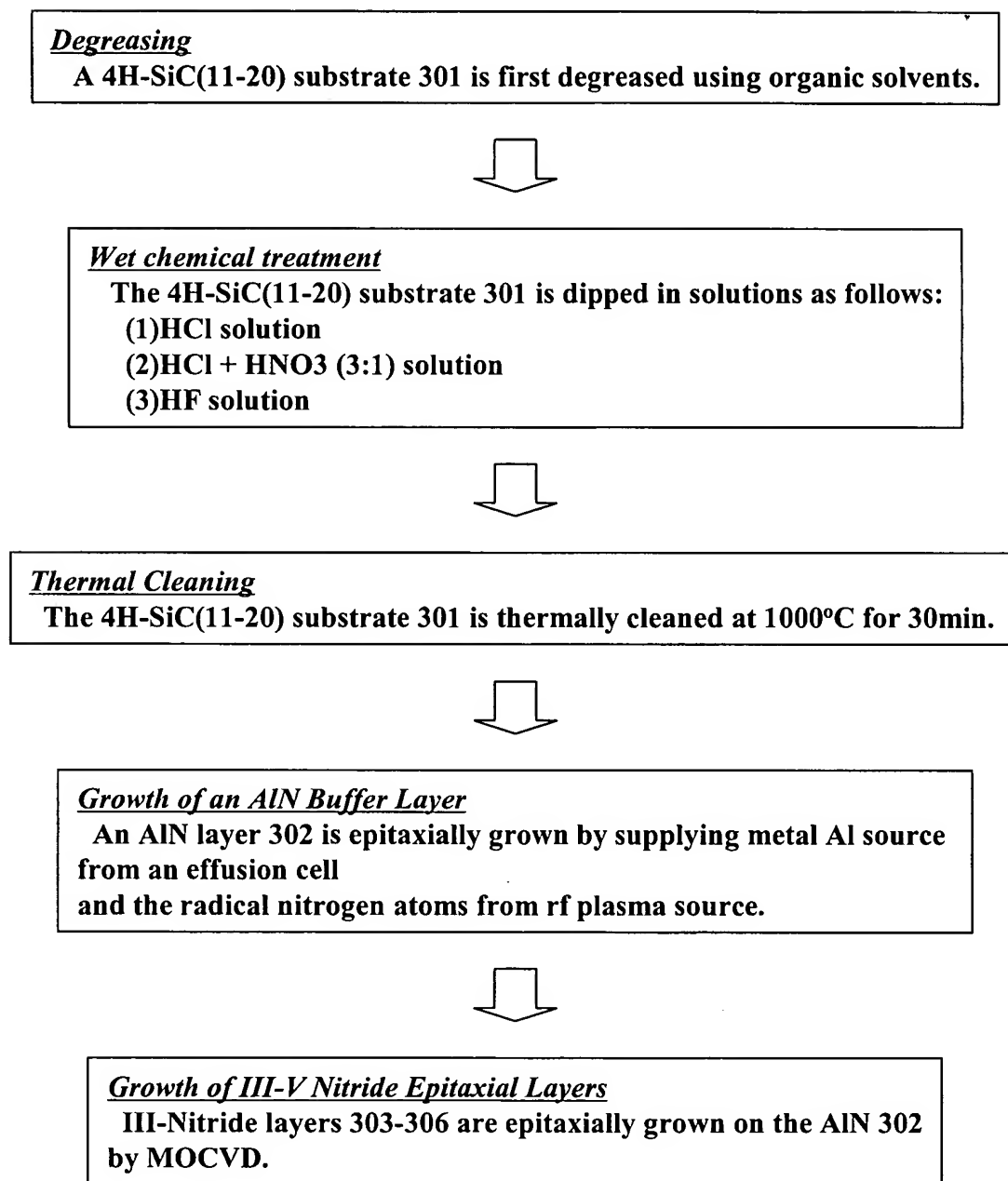


Fig. 8

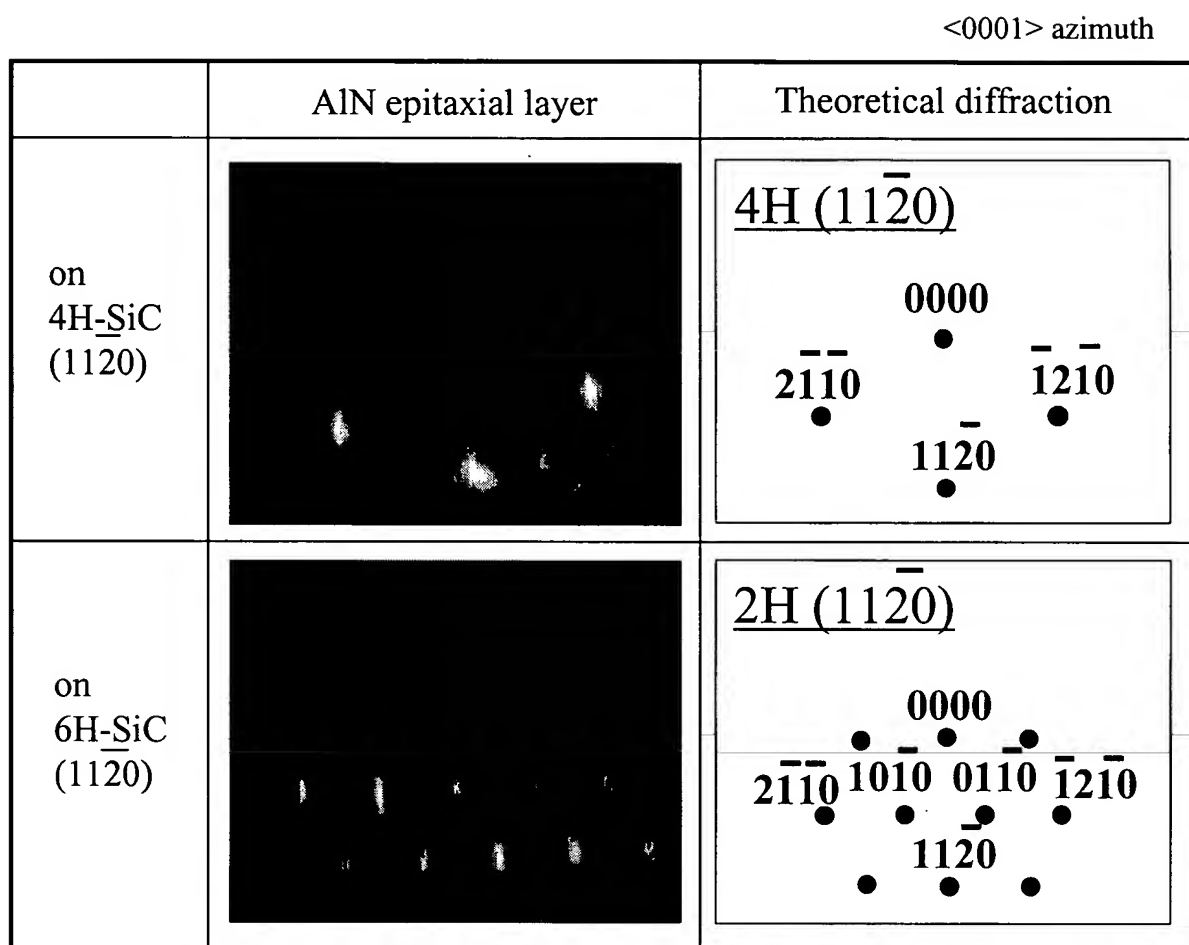


Fig. 9

RHEED patterns of AlN layer on a 4H-SiC(11-20) substrate and on a 6H-SiC(11-20) substrate

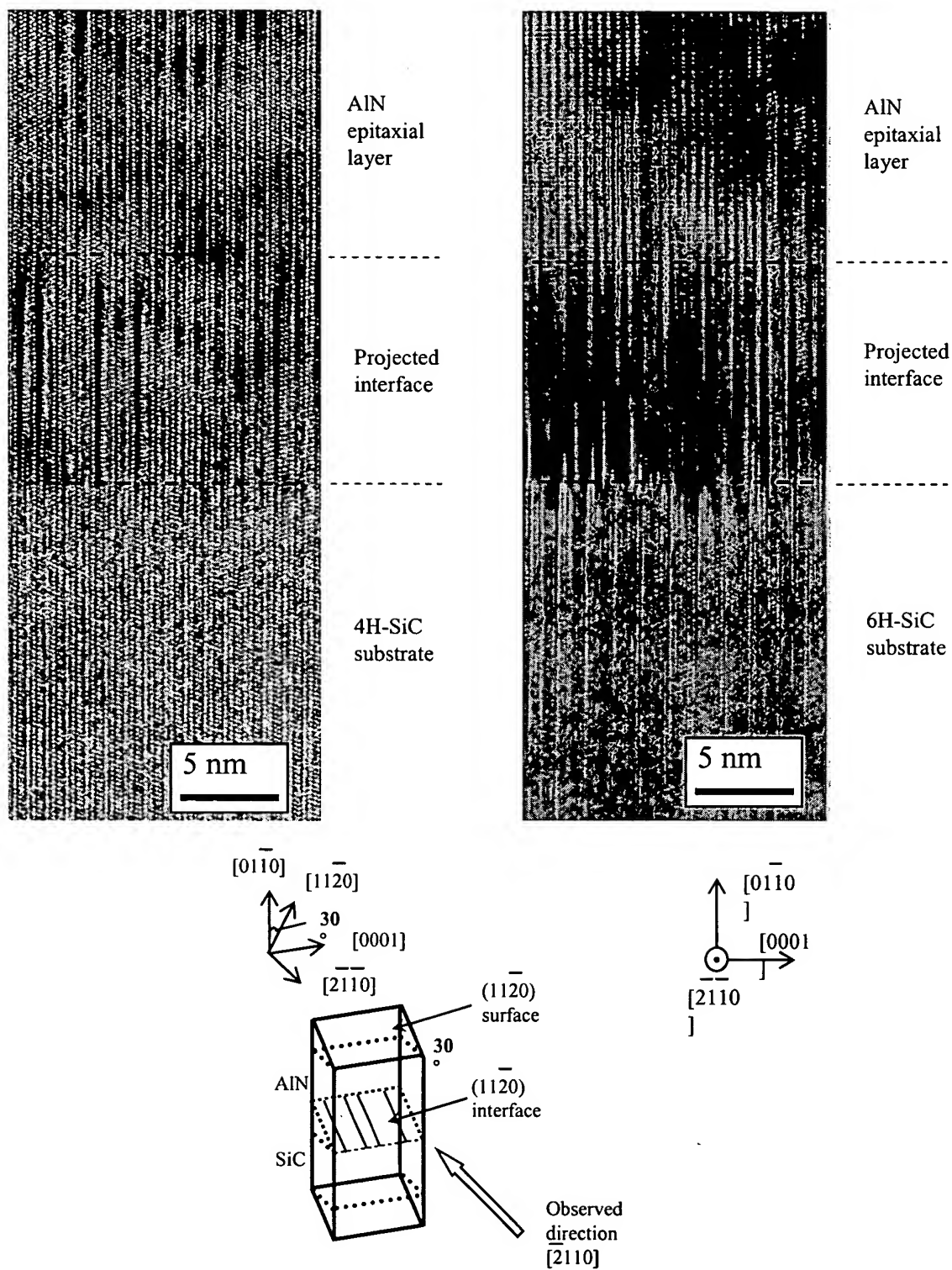


Fig. 10

Lattice images of AlN on 4H-SiC(11-20) and AlN on 6H-SiC(11-20) measured by HRTEM

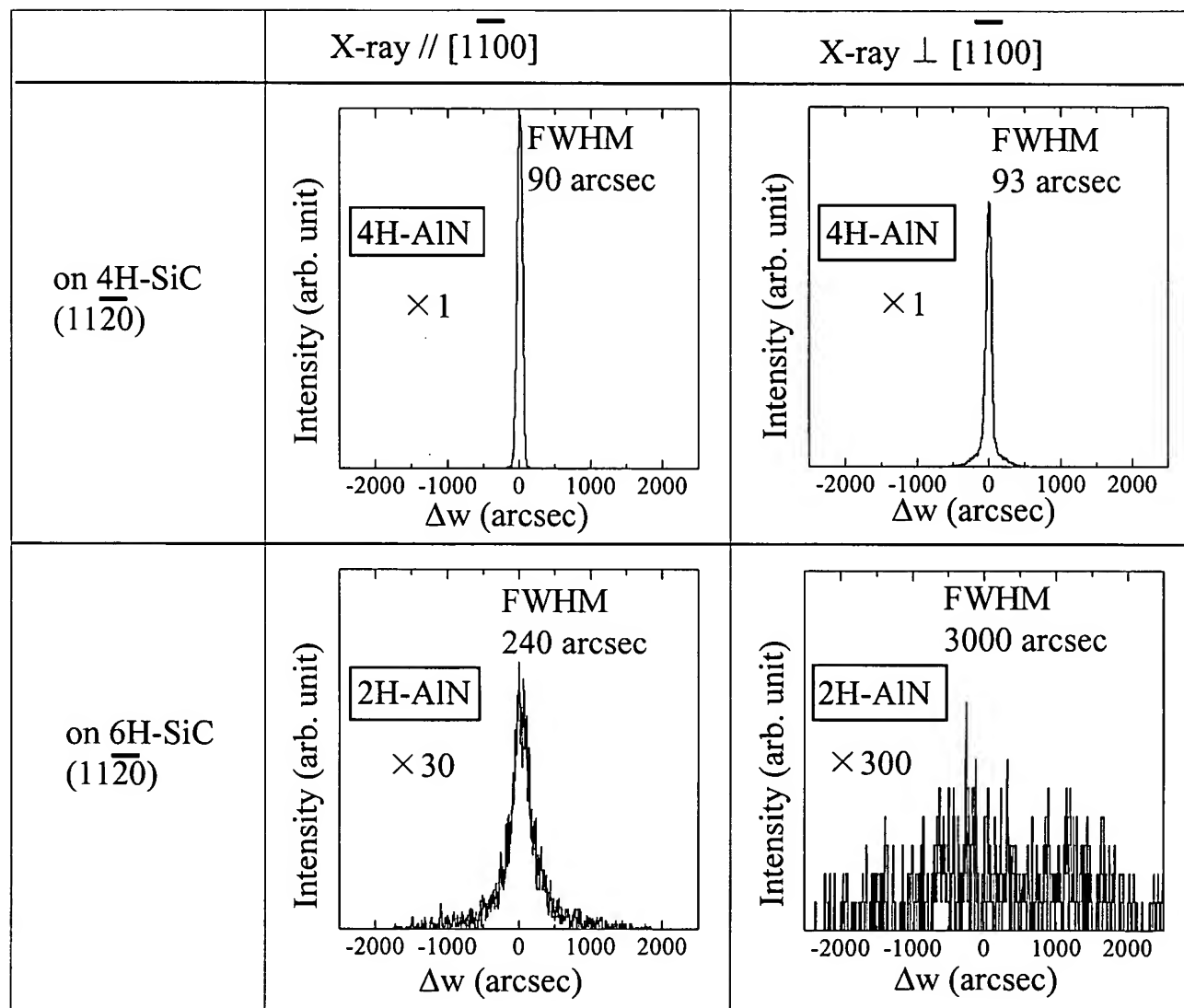
XRC (11 $\bar{2}$ 0) diffraction

Fig. 11

X-ray rocking curve profiles on (11-20) diffraction for AlN on 4H-SiC(11-20) and on 6H-SiC(11-20)

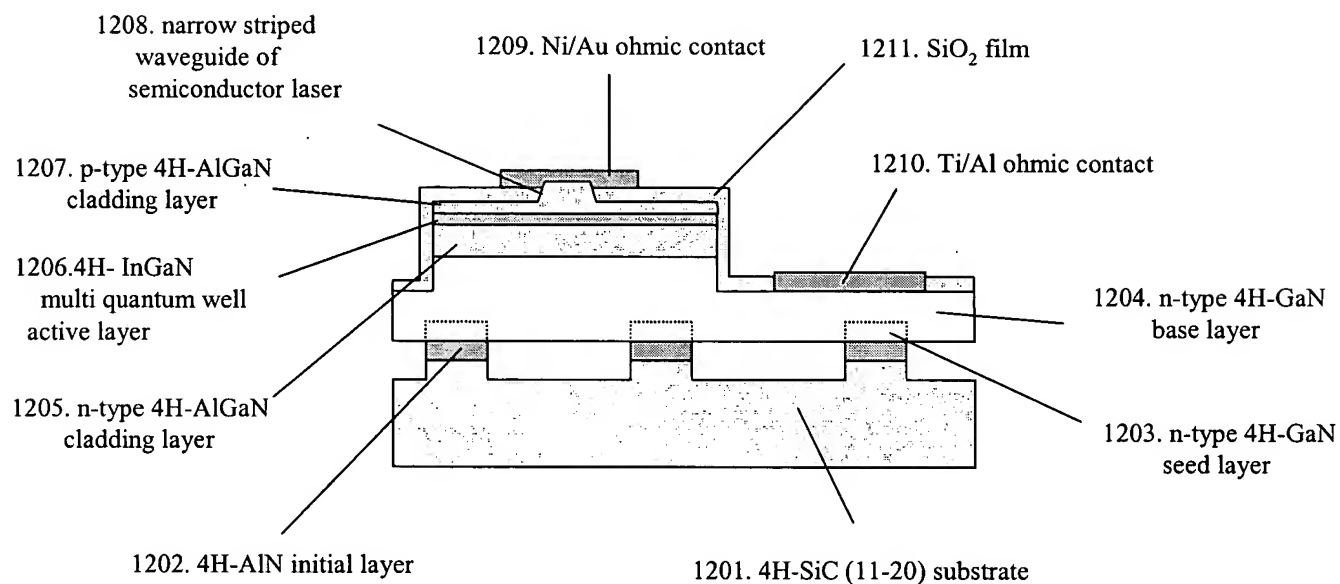
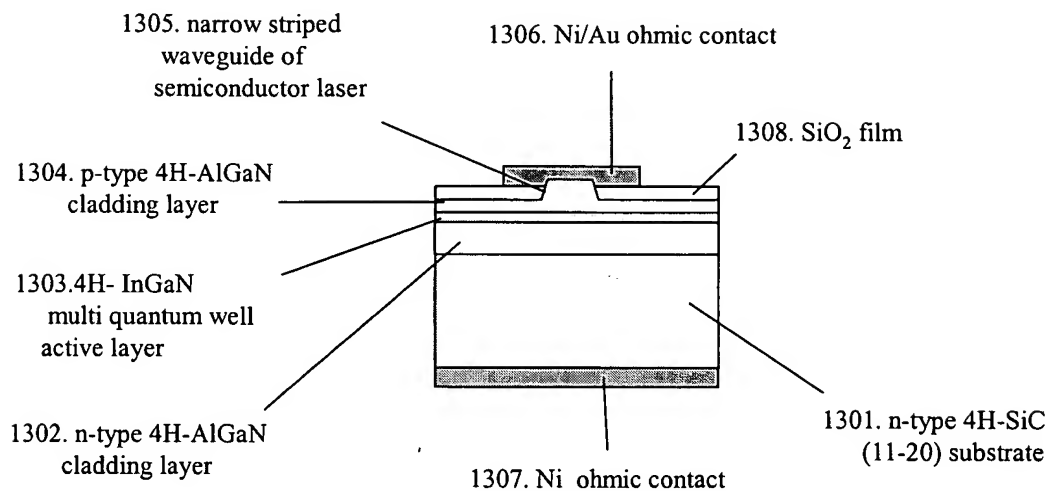
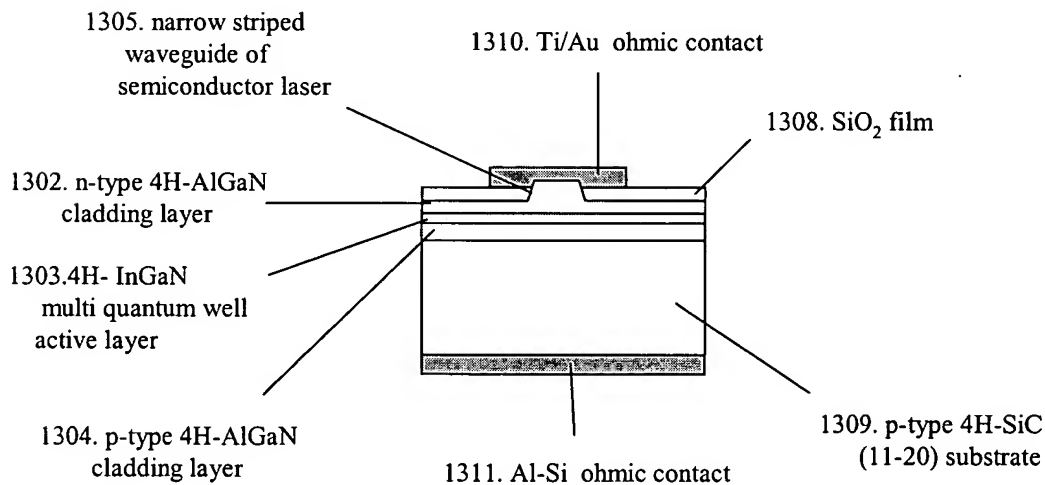


Fig. 12

Cross section of a III-V nitride-based blue-violet semiconductor laser with 4H-polytype on 4H-AlN/4H-SiC. After the selective etching of GaN/AlN to make narrow stripe on the SiC substrate, laser structure is regrown on it.



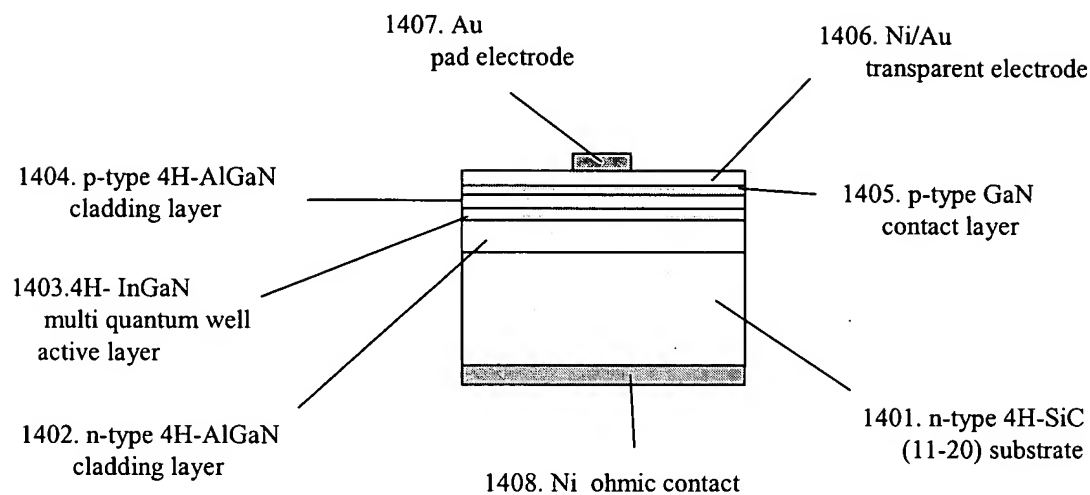
(a) On n-type 4H-SiC(11-20)



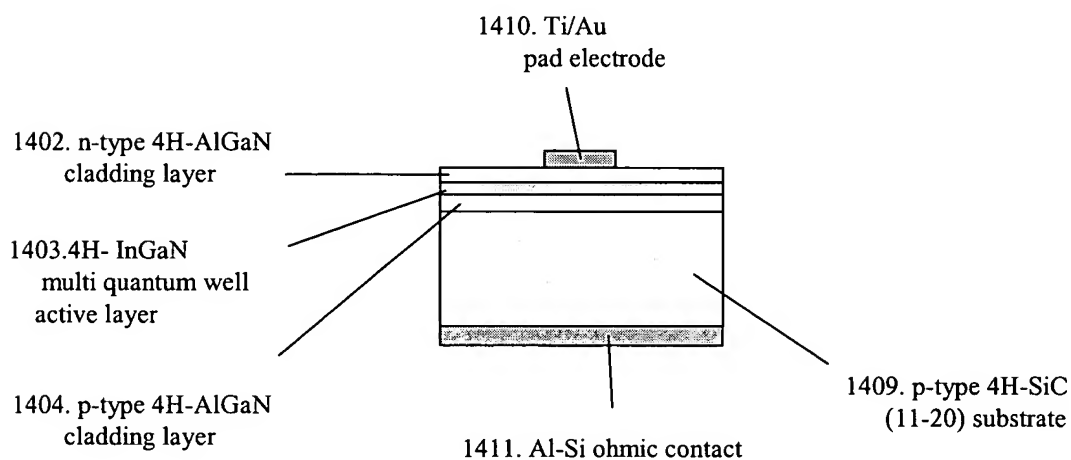
(b) On p-type 4H-SiC(11-20)

Fig. 13

Cross section of a III-V nitride-based blue-violet semiconductor laser with 4H-polytype on 4H-AlN/4H-SiC. Electrodes are formed on the both sides of the device in which current flows through the conductive substrate and the conductive initial Al(Ga)N layer.



(a) On n-type 4H-SiC(11-20)



(b) On p-type 4H-SiC(11-20)

Fig. 14

Cross section of a III-V nitride-based ultraviolet LED with 4H-polytype on 4H-AlN/4H-SiC. Electrodes are formed on the both sides of the device in which current flows through the conductive substrate and the conductive initial Al(Ga)N layer.

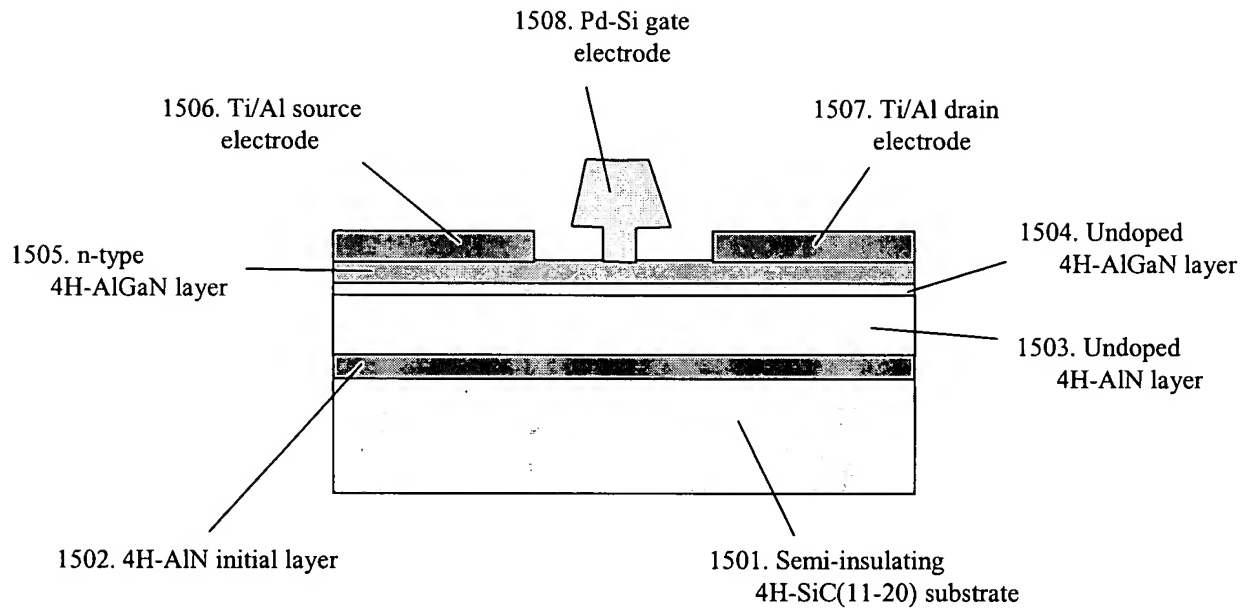


Fig. 15

Cross section of a III-V nitride-based heterostructure transistor with 4H-polytype on 4H-AlN/4H-SiC.